

**A T 9 3 C 5 6 B - S S H M - B**

**Product Family**

93C = Microwire-compatible  
Three-Wire Serial EEPROM

**Device Density**

56 = 2-Kilobit  
66 = 4-Kilobit

**Device Revision**

**Shipping Carrier Option**

B = Bulk

T = Tape and Reel, Standard Quantity Option

E = Tape and Reel, Extended Quantity Option

**Operating Voltage**

M = 1.7V to 5.5V

**Package Device Grade or  
Wafer/Die Thickness**

H or U = Industrial Temperature Range  
(-40°C to +85°C)

11 = 11mil Wafer Thickness

**Package Option**

SS = SOIC

X = TSSOP

MA = 2.0mm x 3.0mm UDFN

C = VFBGA

WWU = Wafer Unsawn